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Jameco Part Number 42850

# HM62256 Series

32768-word x 8-bit High Speed CMOS Static RAM

## ■ FEATURES

- High Speed: Fast Access Time 85/100/120/150ns (max.)
- Low Power Standby and Low Power Operation;  
Standby: 200 $\mu$ W (typ)/10 $\mu$ W (typ) (L-version),  
Operation: 40mW (typ.) ( $f = 1$ MHz)
- Single 5V Supply
- Completely Static RAM: No clock or Timing Strobe Required
- Equal Access and Cycle Time
- Common Data Input and Output, Three-state Output
- Directly TTL Compatible: All Input and Output
- Capability of Battery Back Up Operation (L-/L-SL version)

## ■ ORDERING INFORMATION

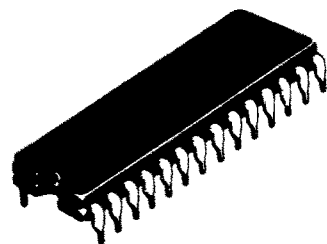
Type No.	Access Time	Package	
HM62256P-8	85ns	600 mil 28 pin Plastic DIP	
HM62256P-10	100ns		
HM62256P-12	120ns		
HM62256P-15	150ns		
HM62256LP-8	85ns		
HM62256LP-10	100ns		
HM62256LP-12	120ns		
HM62256LP-15	150ns		
HM62256LP-10SL	100ns		28 pin Plastic SOP
HM62256LP-12SL	120ns		
HM62256LP-15SL	150ns		
HM62256FP-8T	85ns		
HM62256FP-10T	100ns		
HM62256FP-12T	120ns		
HM62256FP-15T	150ns		
HM62256LFP-8T	85ns		
HM62256LFP-10T	100ns		
HM62256LFP-12T	120ns		
HM62256LFP-15T	150ns		
HM62256LFP-10SLT	100ns		
HM62256LFP-12SLT	120ns		
HM62256LFP-15SLT	150ns		

## ■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on any pin with relative to $V_{SS}$	$V_T$	-0.5*1 to +7.0	V
Power Dissipation	$P_T$	1.0	W
Operating Temperature	$T_{opr}$	0 to +70	°C
Storage Temperature	$T_{stg}$	-55 to +125	°C
Temperature Under Bias	$T_{bias}$	-10 to +85	°C

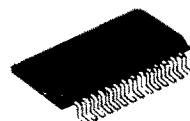
Note) \*1. -3.0V for pulse width  $\leq 50$ ns

HM62256P Series



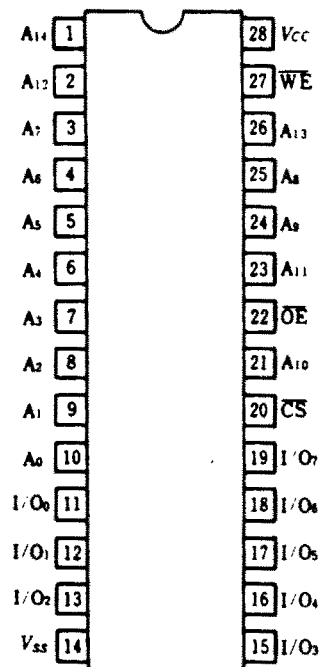
(DP-28)

HM62256FP Series



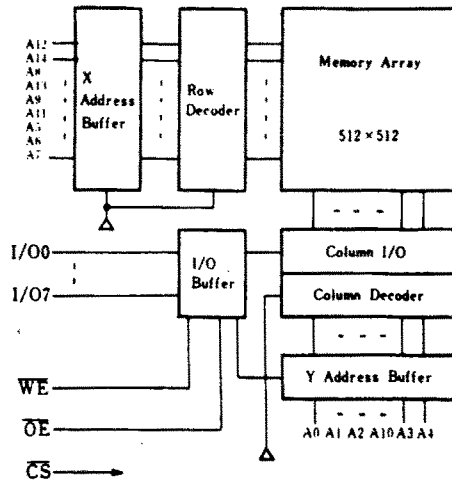
(FP-28DA)

## ■ PIN ARRANGEMENT



(Top View)

■ BLOCK DIAGRAM



■ TRUTH TABLE

$\overline{CS}$	$\overline{OE}$	$\overline{WE}$	Mode	$V_{CC}$ Current	I/O Pin	Reference Cycle
H	X	X	Not Selected	$I_{SB}, I_{SBI}$	High Z	-
L	L	H	Read	$I_{CC}$	Dout	Read Cycle No. 1~3
L	H	L	Write	$I_{CC}$	Din	Write Cycle No. 1
L	L	L	Write	$I_{CC}$	Din	Write Cycle No. 2

X means H or L

■ RECOMMENDED DC OPERATING CONDITIONS ( $T_a = 0$  to  $+70^\circ\text{C}$ )

Item	Symbol	min.	typ.	max.	Unit
Supply Voltage	$V_{CC}$	4.5	5.0	5.5	V
	$V_{SS}$	0	0	0	V
Input Voltage	$V_{IH}$	2.2	-	6.0	V
	$V_{IL}$	$-0.5^{*1}$	-	0.8	V

Note) \*1.  $-3.0\text{V}$  for pulse width  $\leq 50\text{ns}$

■ DC AND OPERATING CHARACTERISTICS ( $V_{CC} = 5\text{V} \pm 10\%$ ,  $V_{SS} = 0\text{V}$ ,  $T_a = 0$  to  $+70^\circ\text{C}$ )

Item	Symbol	Test Condition	min	typ*1	max	Unit
Input Leakage Current	$ I_{LI} $	$V_{IN} = V_{SS}$ to $V_{CC}$	-	-	2	$\mu\text{A}$
Output Leakage Current	$ I_{LO} $	$\overline{CS} = V_{IH}$ or $\overline{OE} = V_{IH}$ or $\overline{WE} = V_{IL}$ , $V_{I/O} = V_{SS}$ to $V_{CC}$	-	-	2	$\mu\text{A}$
Operating Power Supply Current	$I_{CC}$	$\overline{CS} = V_{IL}$ , $I_{I/O} = 0\text{mA}$	-	8	15	$\text{mA}$
Average Operating Power Supply Current	HM62256-8	Min. Cycle, duty=100%, $\overline{CS} = V_{IL}$ , $I_{I/O} = 0\text{mA}$	-	50	70	$\text{mA}$
	HM62256-10		-	40	70	
	HM62256-12		-	35	70	
	HM62256-15		-	33	70	
Standby Power Supply Current	$I_{CC2}$	$\overline{CS} = V_{IL}$ , $V_{IH} = V_{CC}$ , $V_{IL} = 0\text{V}$ , $I_{I/O} = 0\text{mA}$ , $f = 1\text{MHz}$	-	8	15	$\text{mA}$
	$I_{SB}$	$\overline{CS} = V_{IH}$	-	0.5	3	$\text{mA}$
	$I_{SBI}$	$\overline{CS} \geq V_{CC} - 0.2\text{V}$ , $0\text{V} \leq V_{IN}$	-	$2^{*2}$	$100^{*2}$	$\mu\text{A}$
		-	$2^{*3}$	$50^{*3}$		
Output Voltage	$V_{OL}$	$I_{OL} = 2.1\text{mA}$	-	-	0.4	V
	$V_{OH}$	$I_{OH} = -1.0\text{mA}$	2.4	-	-	V

Notes) \*1. Typical values are at  $V_{CC} = 5.0\text{V}$ ,  $T_a = 25^\circ\text{C}$  and specified loading.

\*2. This characteristics is guaranteed only for L-version.

\*3. This characteristics is guaranteed only for L-SL version.

## ■ CAPACITANCE ( $T_a=25^\circ\text{C}$ , $f=1\text{MHz}$ )

Item	Symbol	Test Condition	typ.	max.	Unit
Input Capacitance	$C_{in}$	$V_{in}=0\text{V}$	-	6	pF
Input/Output Capacitance	$C_{I/O}$	$V_{I/O}=0\text{V}$	-	8	pF

Note) This parameter is sampled and not 100% tested.

## ■ AC CHARACTERISTICS ( $V_{CC}=5\text{V}\pm 10\%$ , $T_a=0$ to $+70^\circ\text{C}$ unless otherwise noted)

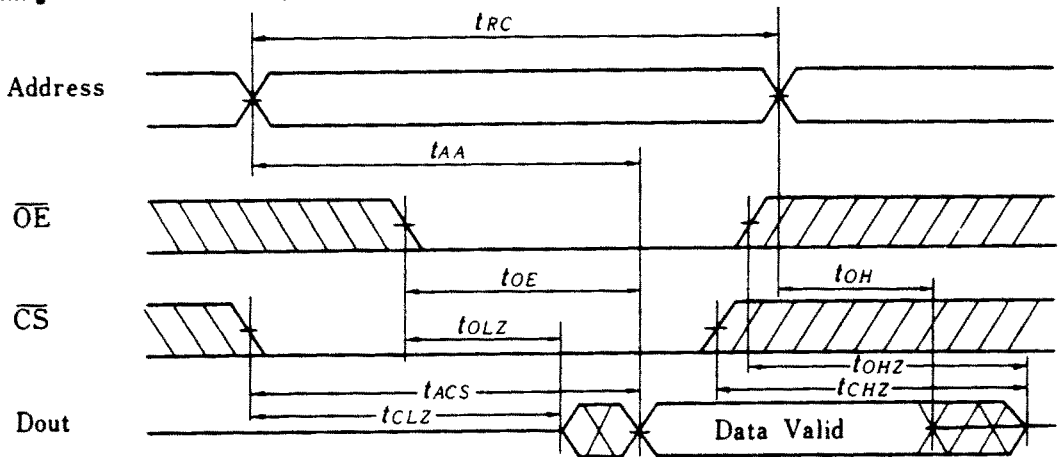
### ● AC Test Conditions

- Input pulse levels: 0.8V to 2.4V
- Input and Output timing reference levels: 1.5V
- Input rise and fall times: 5ns
- Output load: 1TTL Gate and  $C_L$  (100pF)  
(Including scope and jig)

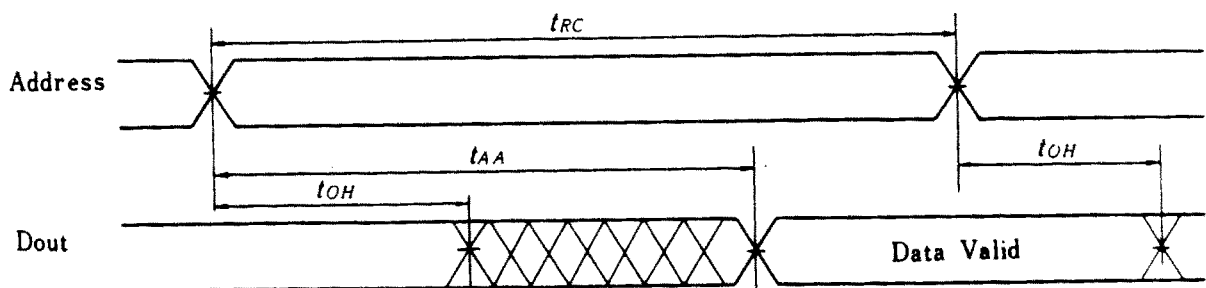
### ● Read Cycle

Item	Symbol	HM62256-8		HM62256-10		HM62256-12		HM62256-15		Unit
		min.	max.	min.	max.	min.	max.	min.	max.	
Read Cycle Time	$t_{RC}$	85	-	100	-	120	-	150	-	ns
Address Access Time	$t_{AA}$	-	85	-	100	-	120	-	150	ns
Chip Select Access Time	$t_{ACS}$	-	85	-	100	-	120	-	150	ns
Output Enable to Output Valid	$t_{OE}$	-	45	-	50	-	60	-	70	ns
Output Hold from Address Change	$t_{OH}$	5	-	10	-	10	-	10	-	ns
Chip Selection to Output in Low Z	$t_{CLZ}$	10	-	10	-	10	-	10	-	ns
Output Enable to Output in Low Z	$t_{OLZ}$	5	-	5	-	5	-	5	-	ns
Chip Deselection to Output in High Z	$t_{CHZ}$	0	30	0	35	0	40	0	50	ns
Output Disable to Output in High Z	$t_{OHZ}$	0	30	0	35	0	40	0	50	ns

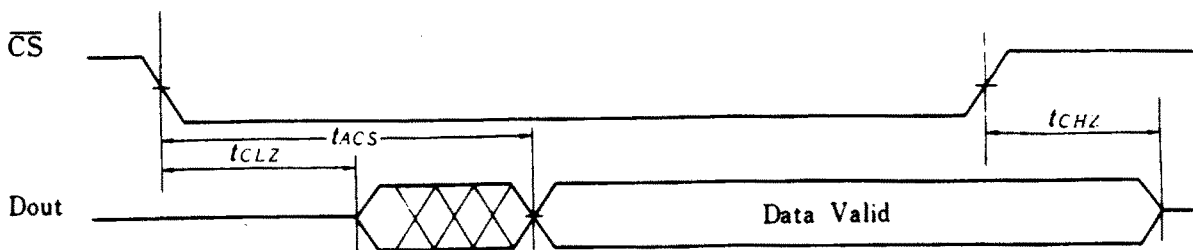
### ● Timing Waveform of Read Cycle No. 1<sup>[1]</sup>



### ● Timing Waveform of Read Cycle No. 2<sup>[1][2][4]</sup>



● Timing Waveform of Read Cycle No. 3<sup>[1][3][4]</sup>

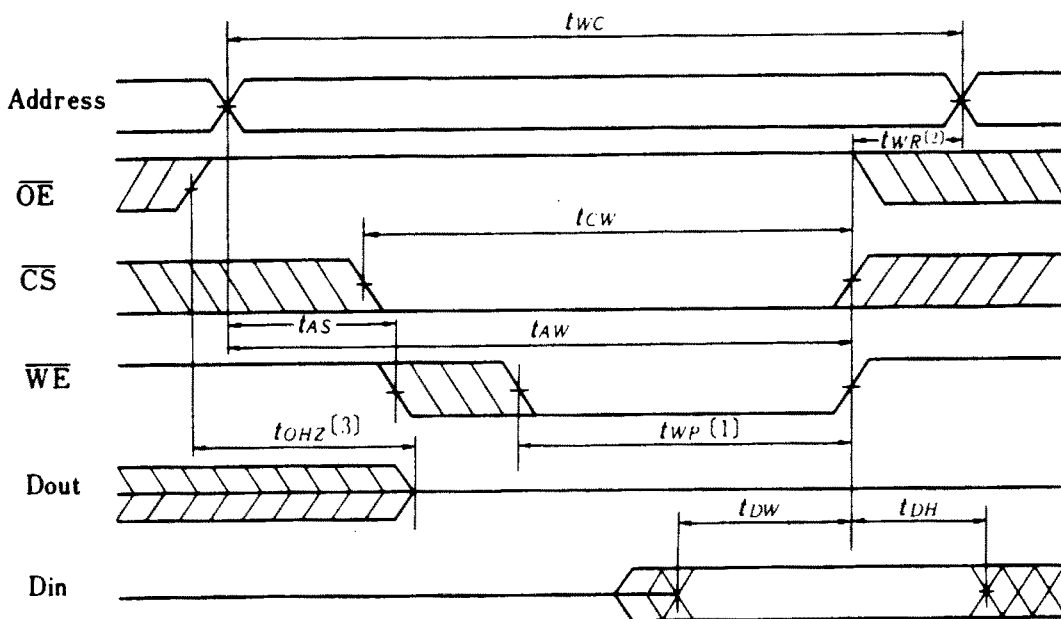


- Notes) 1. WE is High for Read Cycle.
- 2. Device is continuously selected,  $\overline{CS} = V_{IL}$ .
- 3. Address Valid prior to or coincident with  $\overline{CS}$  transition Low.
- 4.  $\overline{OE} = V_{IL}$ .

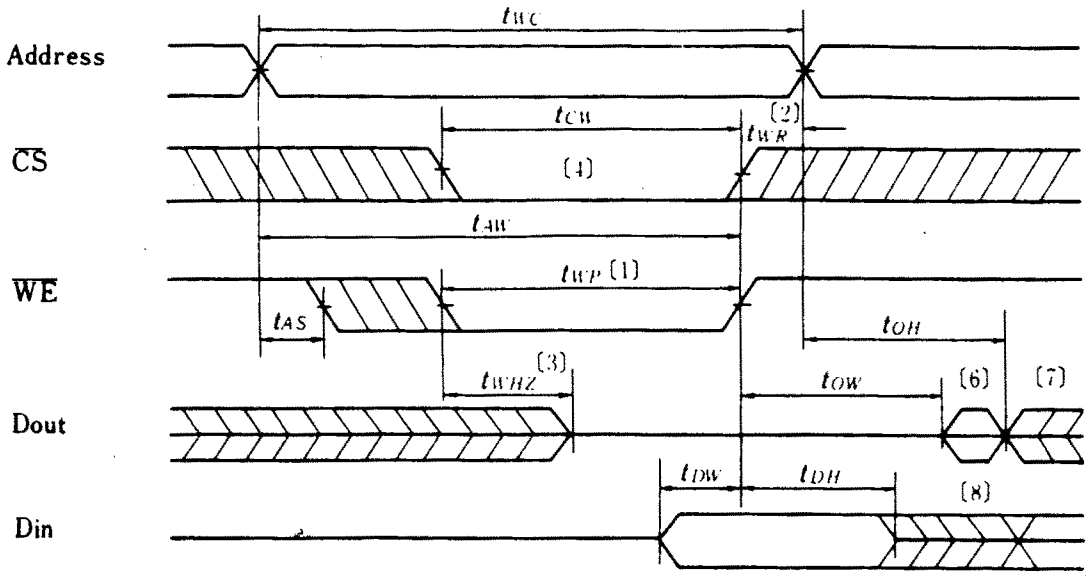
● Write Cycle

Item	Symbol	HM62256-8		HM62256-10		HM62256-12		HM62256-15		Unit
		min.	max.	min.	max.	min.	max.	min.	max.	
Write Cycle Time	$t_{WC}$	85	-	100	-	120	-	150	-	ns
Chip Selection to End of Write	$t_{CW}$	75	-	80	-	85	-	100	-	ns
Address Valid to End of Write	$t_{AW}$	75	-	80	-	85	-	100	-	ns
Address Set Up Time	$t_{AS}$	0	-	0	-	0	-	0	-	ns
Write Pulse Width	$t_{WP}$	60	-	60	-	70	-	90	-	ns
Write Recovery Time	$t_{WR}$	10	-	0	-	0	-	0	-	ns
Write to Output in High Z	$t_{WHZ}$	0	30	0	35	0	40	0	50	ns
Data to Write Time Overlap	$t_{DW}$	40	-	40	-	50	-	60	-	ns
Data Hold from Write Time	$t_{DH}$	0	-	0	-	0	-	0	-	ns
Output Disable to Output in High Z	$t_{OHZ}$	0	30	0	35	0	40	0	50	ns
Output Active from End of Write	$t_{OW}$	5	-	5	-	5	-	5	-	ns

● Timing Waveform of Write Cycle No. 1 ( $\overline{OE}$  Clock)



● Timing Waveform of Write Cycle No. 2<sup>(5)</sup> ( $\overline{OE}$  Low Fixed)



- Notes:
1. A write occurs during the overlap ( $t_{WP}$ ) of a low  $\overline{CS}$  and a low  $\overline{WE}$ .
  2.  $t_{WR}$  is measured from the earlier of  $\overline{CS}$  or  $\overline{WE}$  going high to the end of write cycle.
  3. During this period, I/O pins are in the output state. The input signals out of phase must not be applied
  4. If the  $\overline{CS}$  low transition occurs simultaneously with the  $\overline{WE}$  low transition or after the  $\overline{WE}$  low transition, outputs remain in a high impedance state.
  5.  $\overline{OE}$  is continuously low. ( $\overline{OE} = V_{IL}$ )
  6.  $D_{out}$  is in the same phase of written data of this write cycle.
  7.  $D_{out}$  is the read data of next address.
  8. If  $\overline{CS}$  is low during this period, I/O pins are in the output state. The input signals out of phase must not be applied to I/O Pins.

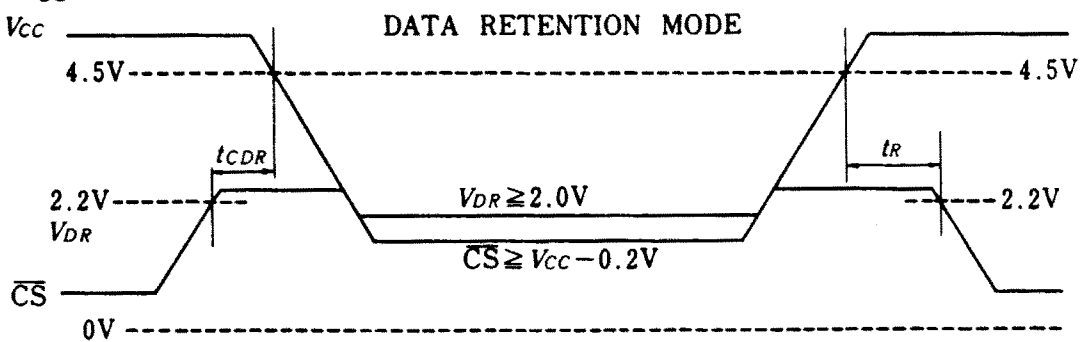
■ LOW  $V_{CC}$  DATA RETENTION CHARACTERISTICS ( $T_a = 0$  to  $+70^\circ\text{C}$ )

(This characteristic is guaranteed only for L-and L-SL version)

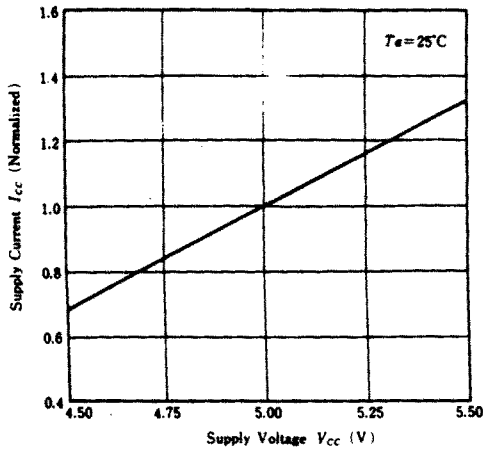
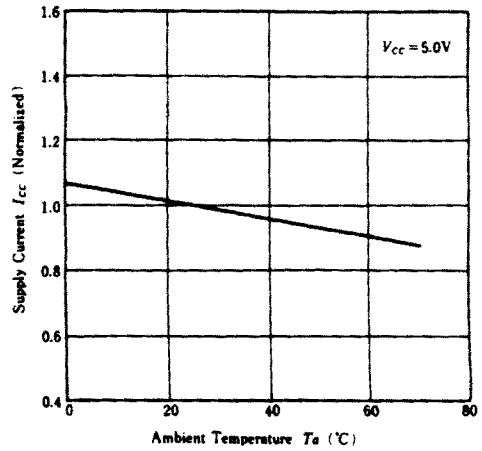
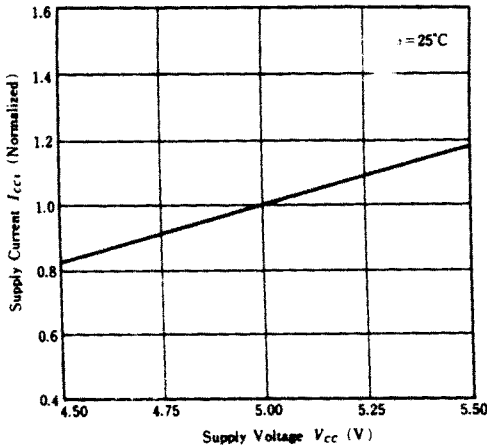
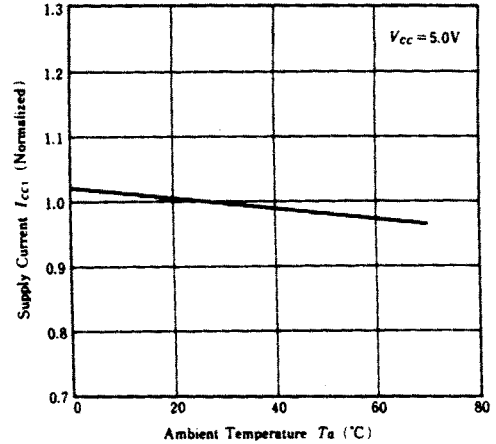
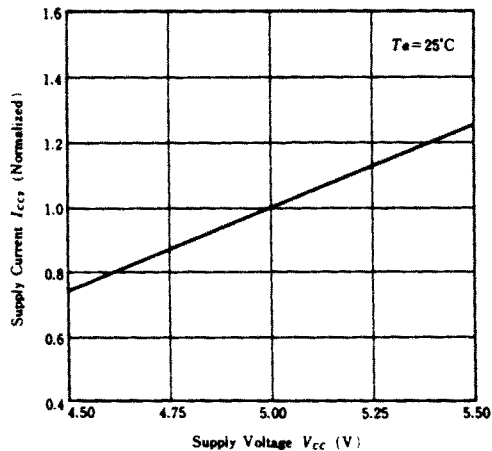
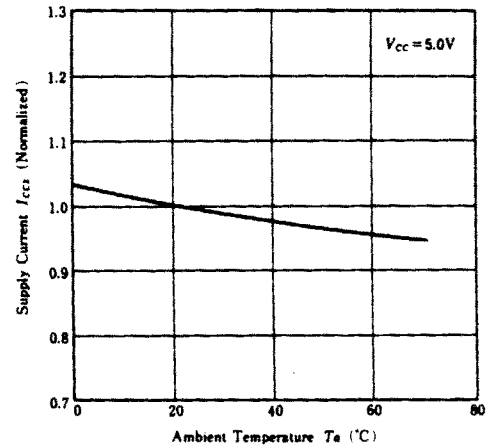
Item	Symbol	Test Conditions	min.	typ.	max.	Unit
$V_{CC}$ for Data Retention	$V_{DR}$	$\overline{CS} \geq V_{CC} - 0.2V$	2.0	-	-	V
Data Retention Current	$I_{CCDR}$	$V_{CC} = 3.0V, \overline{CS} \geq 2.8V$ $0V \leq V_{in}$	-	-	50 <sup>*2</sup>	$\mu A$
			-	-	10 <sup>*3</sup>	
Chip Deselect to Data Retention Time	$t_{CDR}$	See Retention Waveform	0	-	-	ns
Operation Recovery Time	$t_R$		$t_{RC}^{*1}$	-	-	ns

- Note)
- \*1.  $t_{RC}$  = Read Cycle Time
  - \*2. This characteristic is guaranteed only for L-version, 20 $\mu A$  max. at  $T_a = 0$  to  $40^\circ\text{C}$ .
  - \*3. This characteristic is guaranteed only for L-SL version, 3 $\mu A$  max. at  $T_a = 0$  to  $40^\circ\text{C}$ .

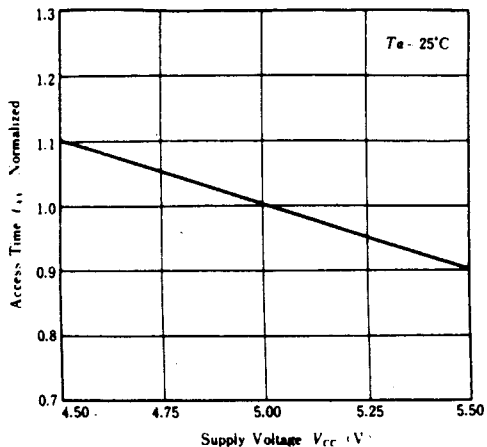
● Low  $V_{CC}$  Data Retention Waveform



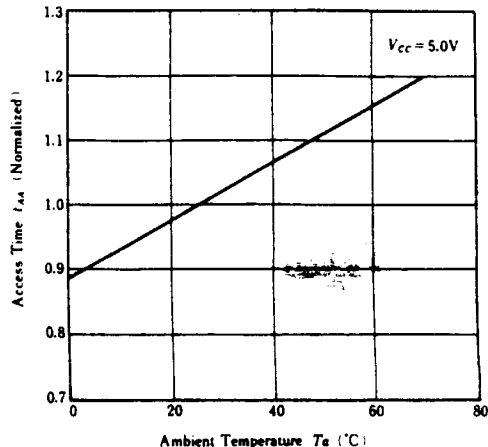
Note) In Data Retention Mode,  $\overline{CS}$  controls the Address,  $\overline{WE}$ ,  $\overline{OE}$ , and  $D_{in}$  Buffers.  $V_{in}$  for these inputs can be in high impedance state in data retention mode.

**SUPPLY CURRENT vs. SUPPLY VOLTAGE (1)****SUPPLY CURRENT vs. AMBIENT TEMPERATURE (1)****SUPPLY CURRENT vs. SUPPLY VOLTAGE (2)****SUPPLY CURRENT vs. AMBIENT TEMPERATURE (2)****SUPPLY CURRENT vs. SUPPLY VOLTAGE (3)****SUPPLY CURRENT vs. AMBIENT TEMPERATURE (3)**

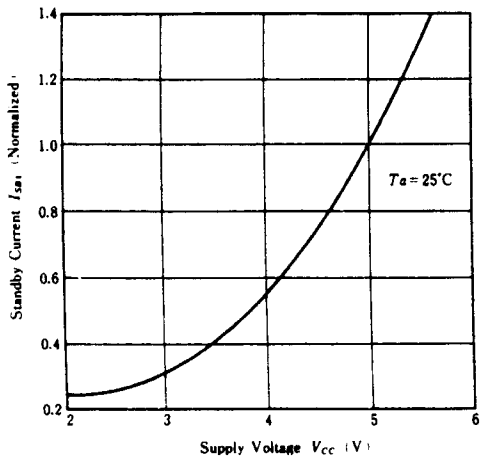
### ACCESS TIME vs. SUPPLY VOLTAGE



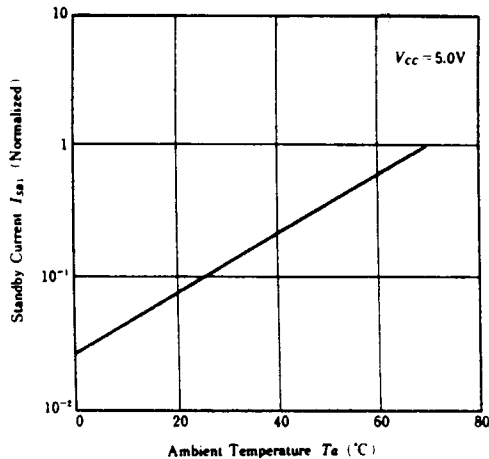
### ACCESS TIME vs. AMBIENT TEMPERATURE



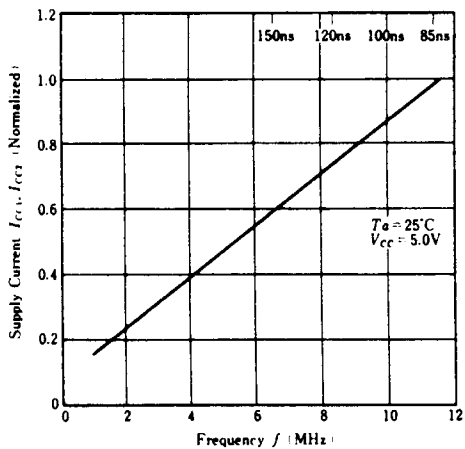
### STANDBY CURRENT vs. SUPPLY VOLTAGE



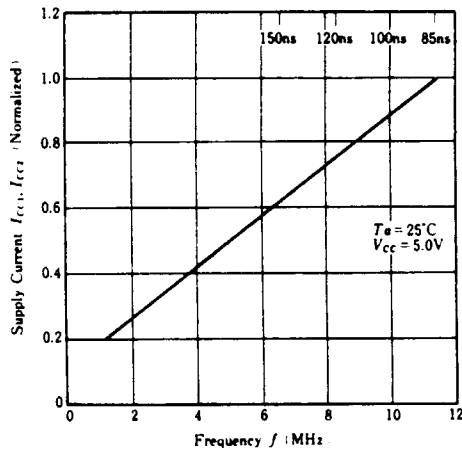
### STANDBY CURRENT vs. AMBIENT TEMPERATURE



### SUPPLY CURRENT vs. FREQUENCY (READ)

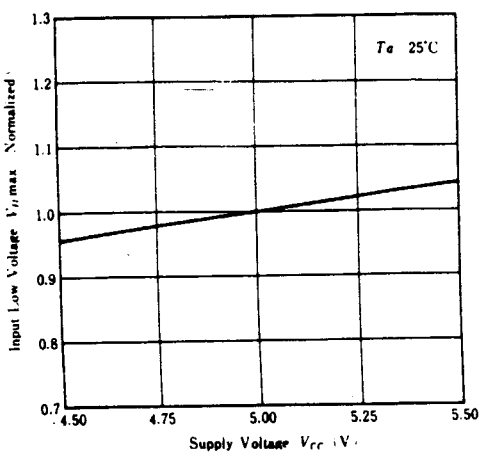


### SUPPLY CURRENT vs. FREQUENCY (WRITE)

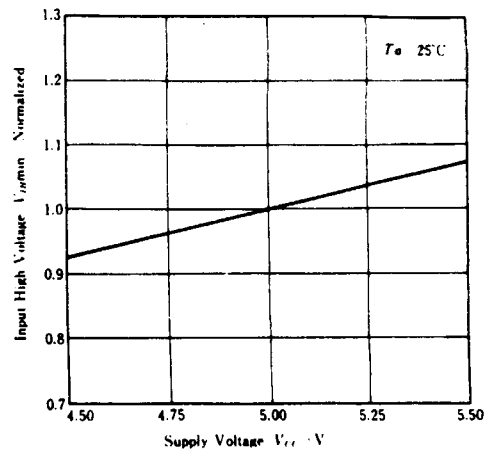




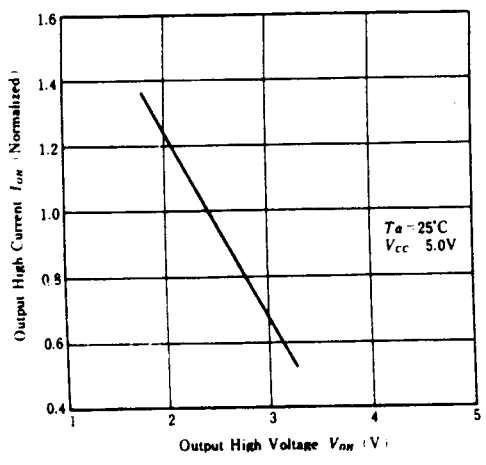
### INPUT LOW VOLTAGE vs. SUPPLY VOLTAGE



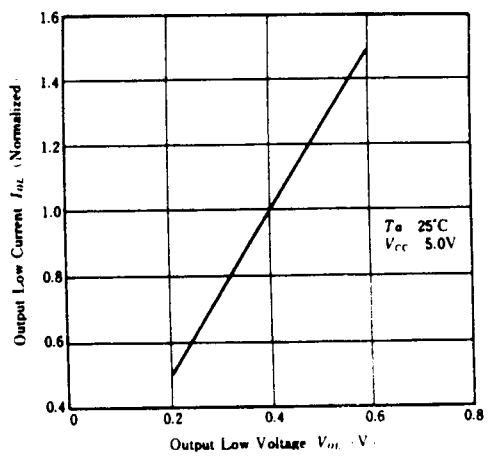
### INPUT HIGH VOLTAGE vs. SUPPLY VOLTAGE



### OUTPUT CURRENT vs. OUTPUT VOLTAGE



### OUTPUT CURRENT vs. OUTPUT VOLTAGE



### ACCESS TIME vs. LOAD CAPACITANCE

